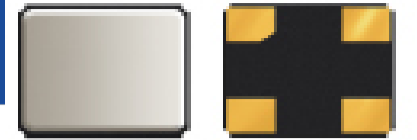


# IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



2.5 x 2.0 x 0.6mm



RoHS/RoHS II Compliant

MSL = N/A: NOT APPLICABLE

## ABM10W SERIES

### FEATURES

- Optimized for energy saving wearables and IoT applications
- Plated at exceptionally low plating capacitance, as low as 4pF, with optimized ESR
- 0.6 mm max height ideally suited for height constrained designs
- Seam sealed for longterm reliability

### APPLICATIONS

- Wearables
- Internet of Things (IoT)
- Bluetooth/Bluetooth Low Energy (BLE)
- Wireless modules
- Machine-to-machine (M2M) connectivity
- Ultra-low power MCU
- Near Field Communication (NFC)
- ISM Band

### STANDARD SPECIFICATIONS

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency Range	16.0000		50.0000	MHz	
Operation Mode	Fundamental				
Operating Temperature Range	-40		+125	°C	See options
Storage Temperature	-55		+125	°C	
Frequency Tolerance @ +25°C	-10		+10	ppm	See options
Frequency Stability over the Operating Temperature ( ref. to +25°C)	-10		+10	ppm	See options
Equivalent series resistance (R1)			100	Ω	16.0000 – 29.9999MHz
			70		30.0000 – 50.0000MHz
Shunt capacitance (C0)		< 1.0	2.0	pF	
Load capacitance (CL)		4.0		pF	See options
Drive Level		10	100	μW	
Aging (1 year)	-2		+2	ppm	@ 25°C±3°C
Insulation Resistance	500			MΩ	@ 100Vdc ± 15V

# IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



ABM10W SERIES

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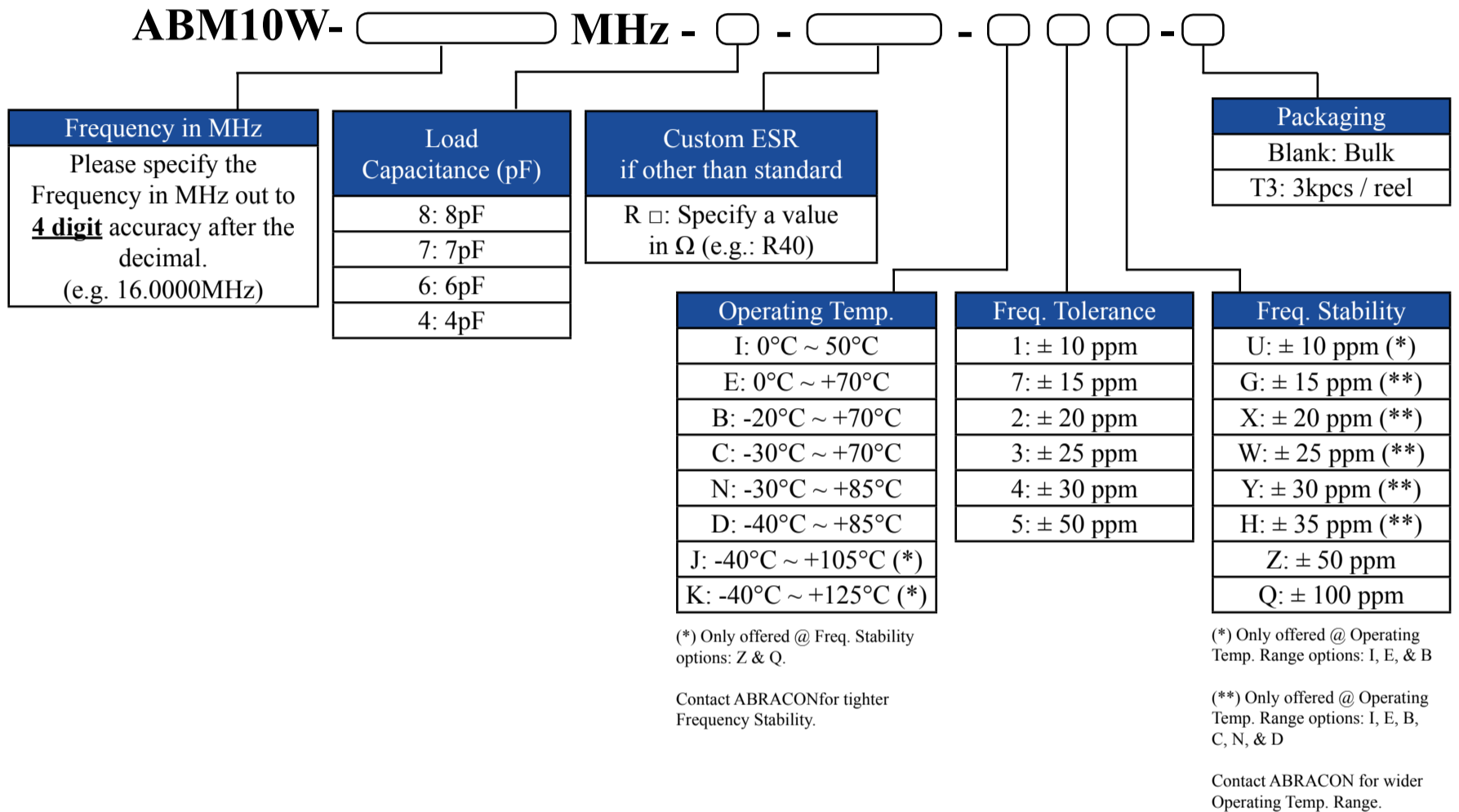


RoHS/RoHS II Compliant

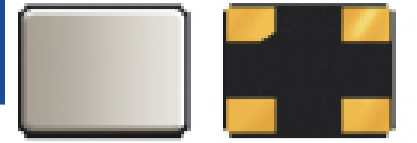
MSL = N/A: NOT APPLICABLE

## OPTIONS AND PART IDENTIFICATION (NOTE 1)

Note 1: Contact Abracon for part number requests with carrier frequency callouts up to 5 & 6 digit accuracy after the decimal.



# IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



ABM10W SERIES

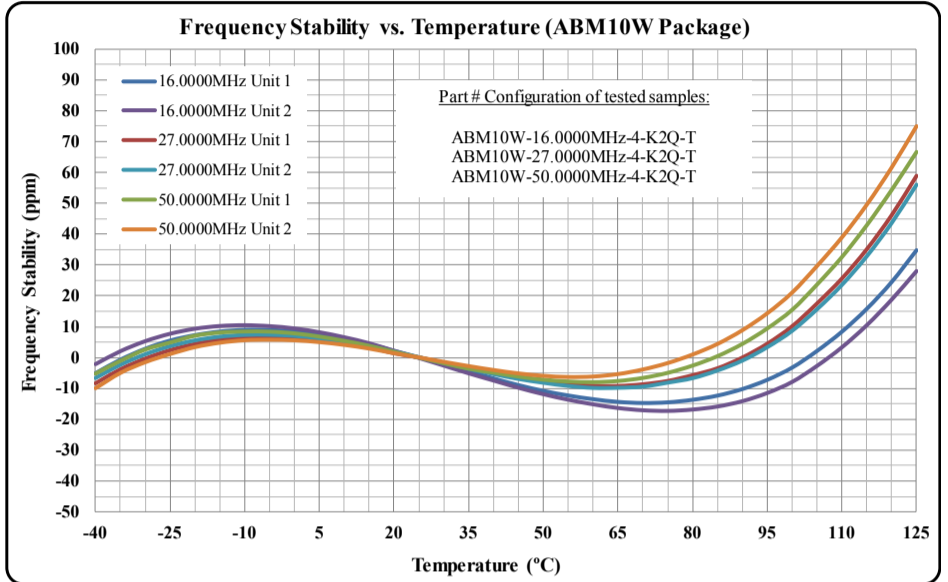
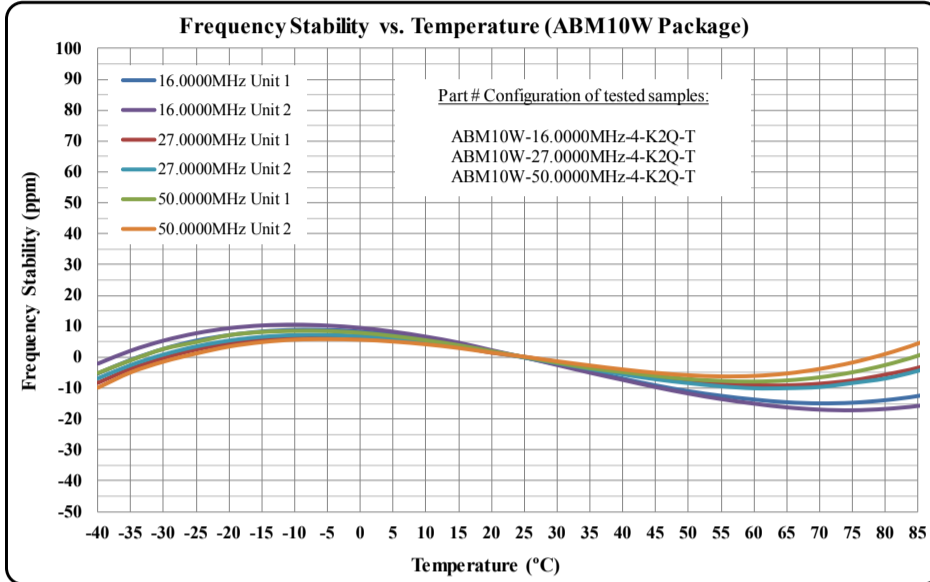
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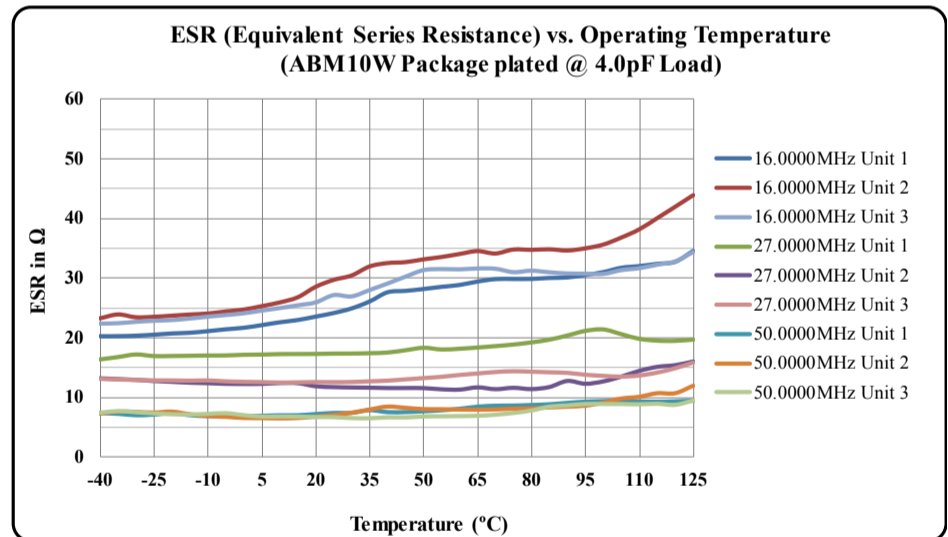
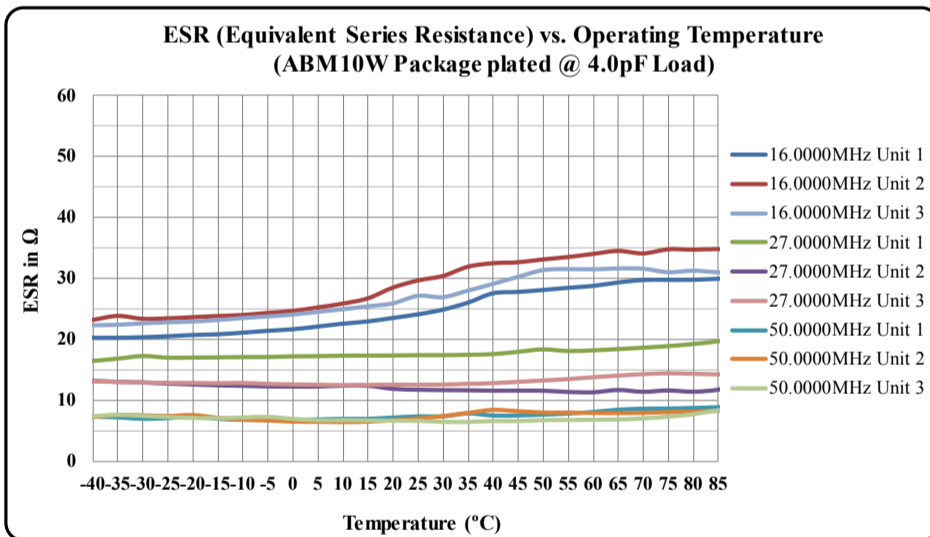
RoHS/RoHS II Compliant

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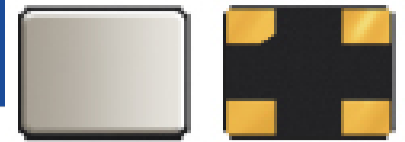
## TYPICAL FREQUENCY Vs. TEMPERATURE CHARACTERISTICS



## TYPICAL ESR (EQUIVALENT SERIES RESISTANCE) Vs. TEMPERATURE CHARACTERISTICS



# IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



ABM10W SERIES

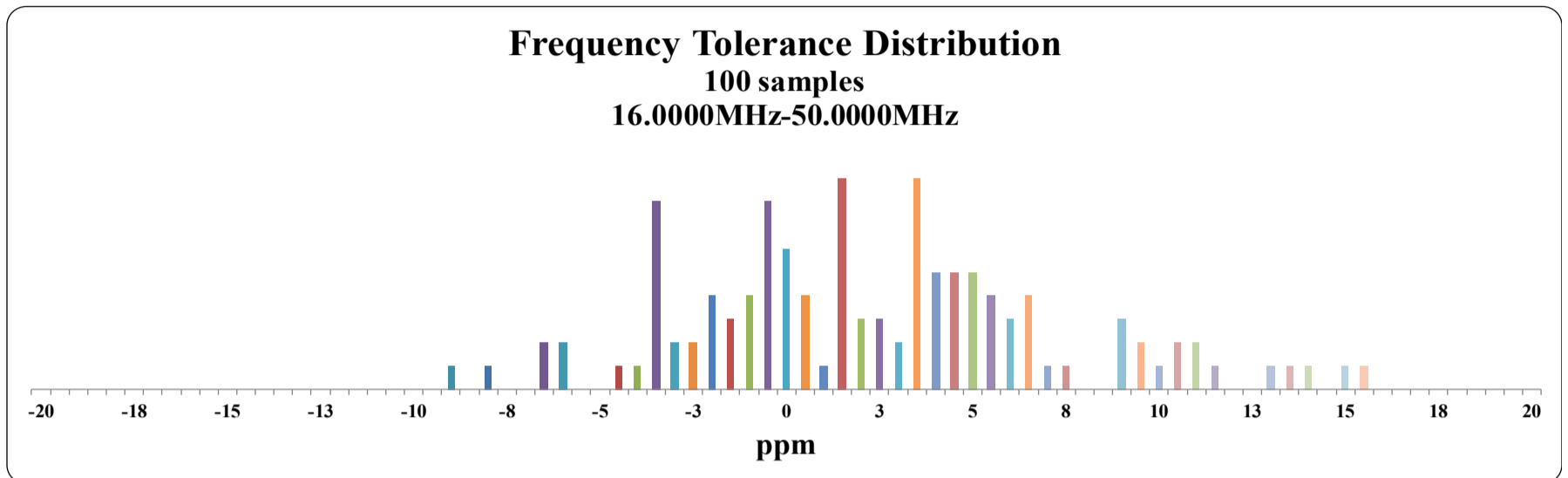
2.5 x 2.0 x 0.6mm



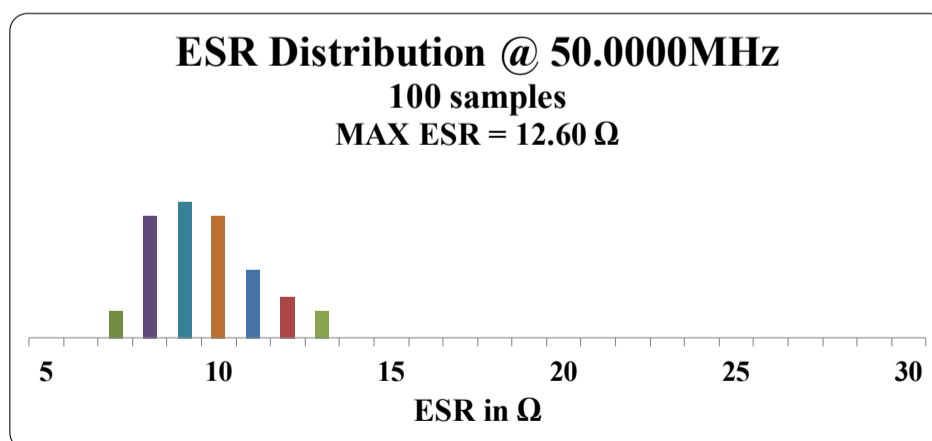
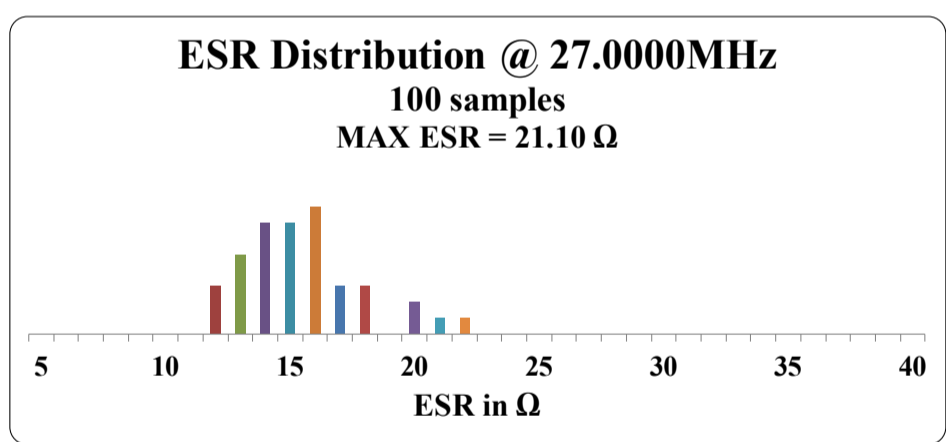
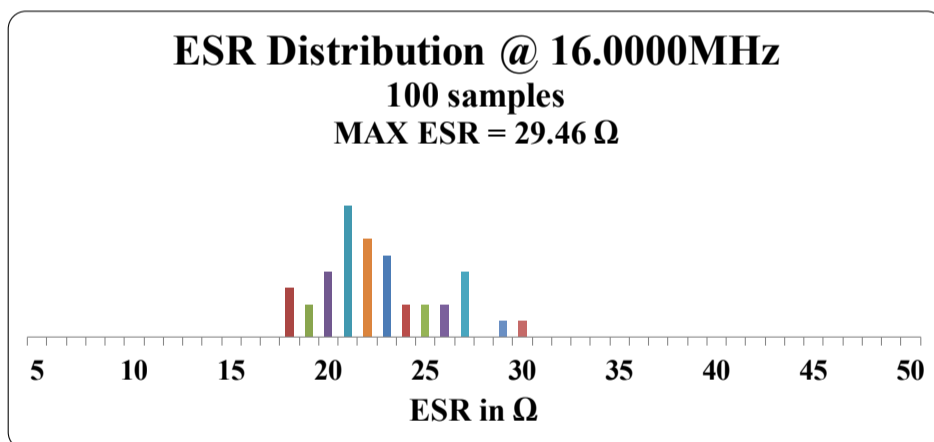
RoHS/RoHS II Compliant

MSL = N/A: NOT APPLICABLE

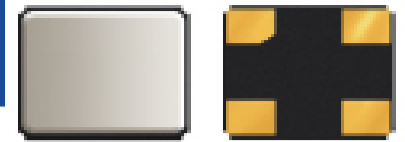
## TYPICAL FREQUENCY TOLERANCE DISTRIBUTION (AT 25°C ± 3°C)



## TYPICAL ESR DISTRIBUTION (AT 25°C ± 3°C)



# IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



ABM10W SERIES

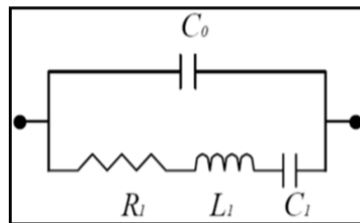
2.5 x 2.0 x 0.6mm



RoHS/RoHS II Compliant

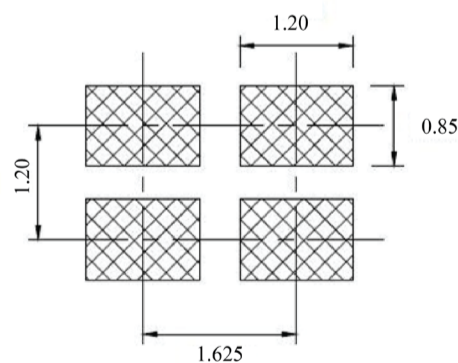
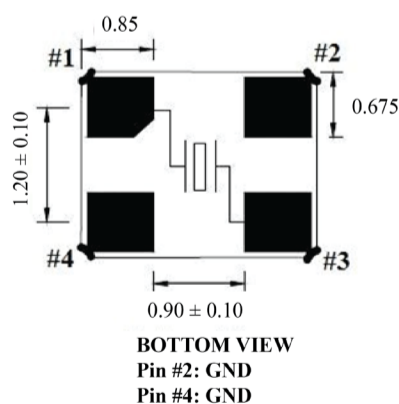
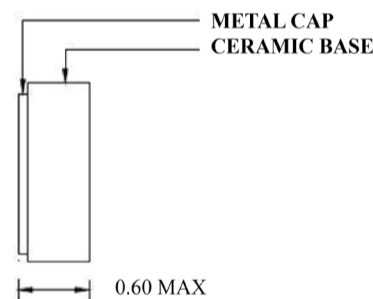
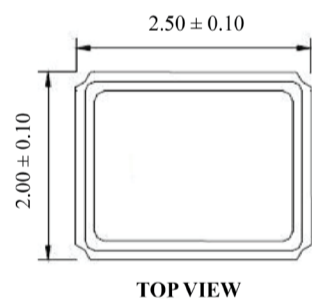
MSL = N/A: NOT APPLICABLE

## SPICE MODELS (BASED ON TYPICAL VALUES AT 25°C ± 3°C)



<b>Frequency: 16.0000MHz</b> <b>Plating Load: 4pF</b>			<b>Frequency: 16.0000MHz</b> <b>Plating Load: 6pF</b>		
C0	=	0.65 pF	C0	=	0.65 pF
R1	=	22.77 Ω	R1	=	21.43 Ω
L1	=	70.34 mH	L1	=	70.13 mH
C1	=	1.41 fF	C1	=	1.41 fF
<b>Frequency: 27.0000MHz</b> <b>Plating Load: 4pF</b>			<b>Frequency: 27.0000MHz</b> <b>Plating Load: 6pF</b>		
C0	=	0.65 pF	C0	=	0.66 pF
R1	=	14.39 Ω	R1	=	17.38 Ω
L1	=	16.51 mH	L1	=	16.56 mH
C1	=	2.11 fF	C1	=	2.10 fF
<b>Frequency: 50.0000MHz</b> <b>Plating Load: 4pF</b>			<b>Frequency: 50.0000MHz</b> <b>Plating Load: 6pF</b>		
C0	=	0.89 pF	C0	=	0.87 pF
R1	=	8.40 Ω	R1	=	8.03 Ω
L1	=	3.24 mH	L1	=	3.19 mH
C1	=	3.13 fF	C1	=	3.18 fF

## MECHANICAL DIMENSIONS

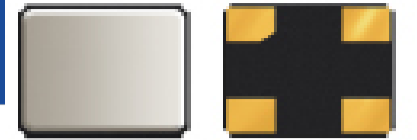


DIMENSIONS: mm

### Note:

Due to material availability the Chamfer could be located on pin #1, 2 or 4. Be advised that the Chamfer location has no impact on the electrical performance of the device.

# IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



ABM10W SERIES

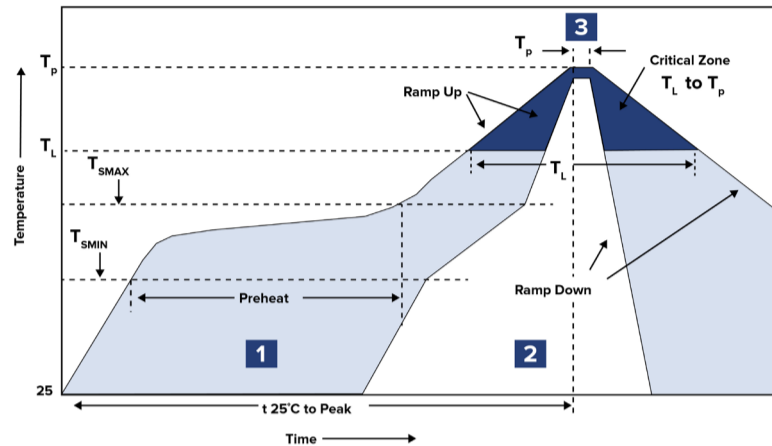
2.5 x 2.0 x 0.6mm



RoHS/RoHS II Compliant

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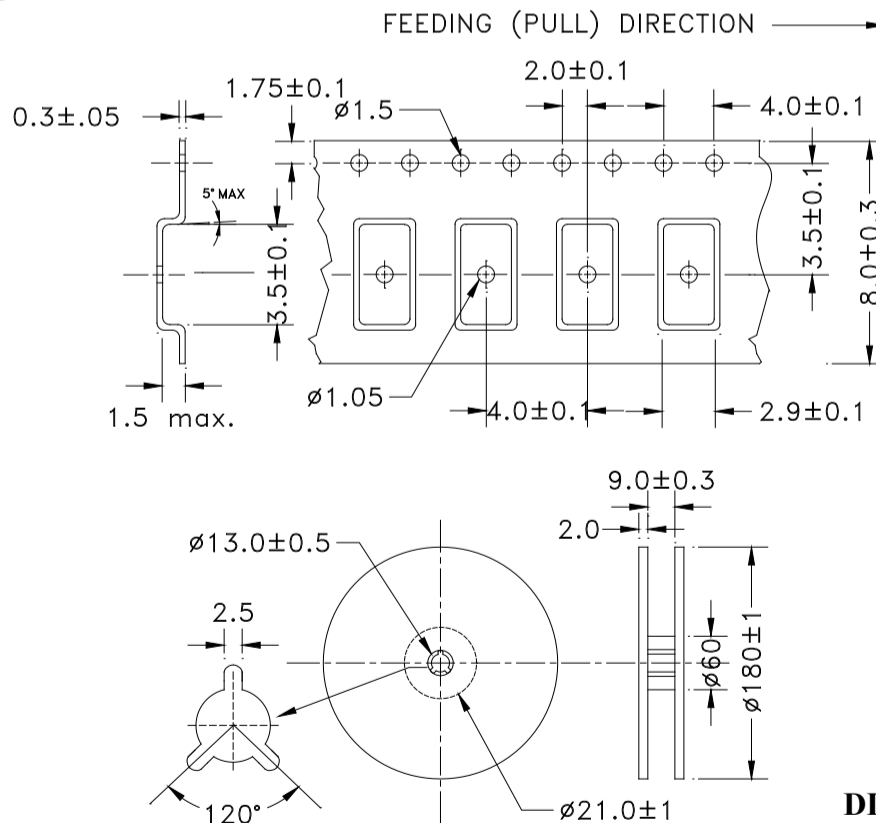
## REFLOW PROFILE



Zone	Description	Temperature	Time
1	Preheat	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 180°C	60 ~ 120 sec.
2	Reflow	$T_L$ 217°C	45 ~ 90 sec.
3	Peak Heat	$T_P$ 260°C MAX	10 sec.

## PACKAGING

T3: Tape and reel (3,000 pcs/reel)



DIMENSIONS: mm